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## IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF:

Byoung Young KANG

: GROUP ART UNIT: 2818

**APPLICATION NO: 10/751,199** 

FILED: December 30, 2003

: EXAMINER: LEE, CALVIN

FOR: METHOD FOR PACKAGING A SEMICONDUCTOR DEVICE

I hereby certify that this document is being facsimile transmitted to the USPTO or deposited with the United States Postal Service as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 17, 2005.

## **AMENDMENT**

Mail Stop AMENDMENT COMMISSIONER FOR PATENTS P.O. BOX 1450 ALEXANDRIA, VA 22313-1450

SIR:

This is in response to the Office Action of February 1, 2005, in connection with the above-identified application. Amendments to the Claims are reflected in the listing of Claims which begins on page 2 of this paper. Amendments to the Drawings begin on page 3 of this paper and include both an attached replacement sheet and an annotated sheet showing changes, which are attached to the last page of this paper. Remarks/Arguments begin on page 4 of this paper.